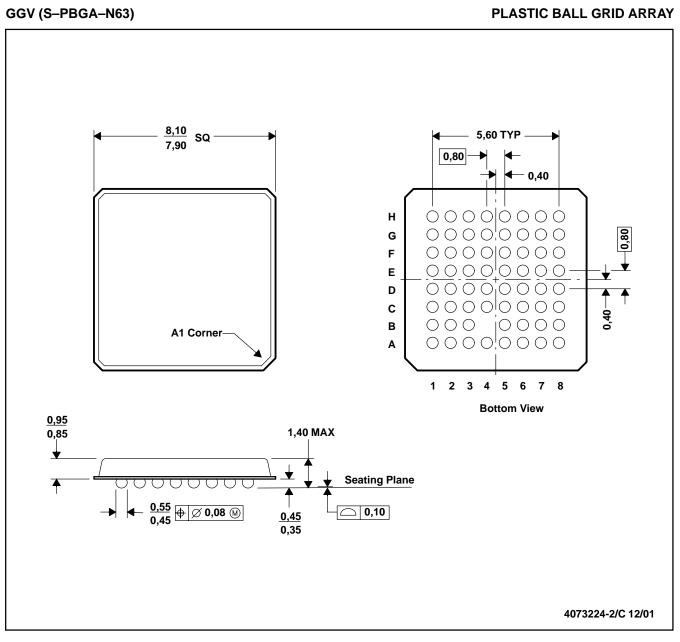
MECHANICAL DATA

MPBG287 - JUNE 2002



- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. MicroStar BGA™ configuration

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Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

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